WHAT IS CLAIMED IS:

| 1 | 1. A method of forming a spin valve sensor, comprising: |
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| 2 | forming a first pinned layer having a first magnetic orientation and a first |
| 3 | width; |
| 4 | forming a second pinned layer having a second magnetic orientation anti- |
| 5 | parallel to the first magnetic orientation; and |
| 6 | forming a sensing layer having a second width smaller than the first width. |
| 1 | 2. The method according to Claim 1, further comprising forming a |
| 2 | coupling layer disposed between the first and second pinned layers. |
| 1 | 3. The method according to Claim 2, wherein the first and second pinned |
| 2 | layers are formed with substantially equal thickness. |
| 1 | 4. The method according to Claim 3, wherein forming the first and |
| 2 | second pinned layers creates self-pinned magnetic orientations. |
| 1 | 5. The method according to Claim 3, further comprising depositing an |
| 2 | anti-ferromagnetic material (AFM) adjacent to the first pinned layer, wherein a |
| 3 | thickness of the AFM creates exchange coupling between the AFM and the first |
| 4 | pinned layer. |

- 1 6. The method according to Claim 1, wherein forming the sensing layer 2 includes: 3 forming a free layer having a third magnetic orientation orthogonal to the first and second magnetic orientations; 4 5 forming a bias layer in proximity to the free layer having a fourth 6 magnetic orientation anti-parallel to the third magnetic orientation; and 7 forming an AFM layer adjacent to the bias layer, wherein exchange 8 coupling between the AFM layer and the bias layer sets the fourth magnetic 9 orientation. 7. The method according to Claim 6, wherein the bias layer is formed 1 2 with a thickness greater than a thickness of the free layer. The method according to Claim 1, wherein the second pinned layer is 8. 1 2 formed with a width substantially equal to the second width. The method according to Claim 8, wherein insulating layers are 2 disposed on both sides of the second pinned layer. The method according to Claim 1, wherein the second pinned layer is 10. 1 2 formed with a width substantially equal to the first width. 1 11. The method according to Claim 1, wherein insulating layers are disposed on both sides of the sensing layer. 2
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